

Silicon Switching Diode

Rev. V2

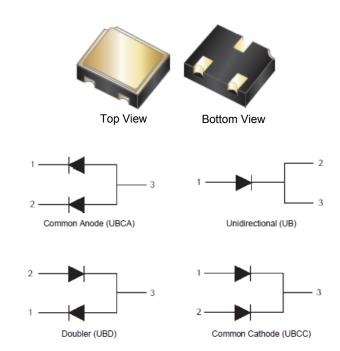
Features

- JAN, JANTX, JANTXV and JANS Qualification is available per MIL-PRF-19500/578/609 (see part nomenclature for all available options)
- Surface Mount Equivalent of JEDEC registered 1N6638 - 1N6643
- Very Low Capacitance
- Very Fast Switching Speeds with Minimal Reverse Recovery Times
- Unidirectional as well as Doubler, Common Anode and Common Cathode Polarities are Available
- RoHS Compliant by Design



The 1N66xxUB Series of switching/signal diodes feature ceramic bodied construction for military grade products per MIL-PRF-19500/578/609. These small, low capacitance diodes, with very fast switching speeds, are featured in a surface mount UB package with various polarities available.

These devices are ideally suited for high frequency data lines, RS-232 & RS-422 interface networks, and Ethernet 10 Base T, LAN & computers.



Electrical Specifications

Part #	V _{BR} @ I _R		V _{RWM}	V _{FR} / t _{FR}		C _T 1	C _T 2	trr
(add UB, UBCA, UBCC, UBD as per part nomenclature)				@ I _F = 200 mA		V _R = 0.0 V	V _R = 1.5 V	I _R = 10 mA, I _F = 10 mA
	V(pk)	μΑ	V(pk)	V(pk)	ns	pF	pF	ns
1N6638	150	100	125	5	20	2.5	2.0	4.5
1N6639	100	10	75	5	10	2.5	_	4
1N6640	75	10	50	5	10	2.5	_	4
1N6641	75	10	50	5	10	3.0	_	5
1N6642	100	100	75	5	20	5.0	2.8	5
1N6643	75	100	50	5	20	5.0	2.8	6



Silicon Switching Diode

Rev. V2

Electrical Specifications

Part #	I _R				V _F @ I _F				I _F
(add UB, UBCA, UBCC, UBD as	V _R = 20 V	V _R = V _{RWM}	V _R = 20 V T _A = +150° C	$V_R = V_{RWM},$ $T_A = +150^{\circ}$ C			T _A = +150°C	T _A = -55°C	
per part nomen- clature)		_	_	_	٧	V	V	٧	mA
	nA	nA	μΑ	μΑ	Min.	Max.	Max.	Max.	(pulsed)
1N6638	35	500	50	100	_	1.1 0.8	- 0.65	1.2 —	200 10
1N6639	_	100	_	90	_	1.2		1.3	500
1N6640	_	100	_	90	0.54 0.76 0.82 0.87	0.62 0.86 0.92 1.0	_	 _ _ 1.1	1 50 100 200
1N6641	_	100	_	90	0.87	1.1	_	1.2	200
1N6642	25	500	50	100	_	0.8 1.2	0.8	 1.2	10 100
1N6643	50	500	75	100	_	0.8 1.2	0.8	 1.4	10 100

Absolute Maximum Ratings @ +25°C (unless otherwise specified)

Part # (add UB, UBCA, UBCC, UBD as per part nomenclature)		Working Peak Reverse Voltage	Average Rectified Current @ T _A = +75°C ¹	Non-Repetitive Sinusoidal Surge Current (tp = 8.3 ms)	Junction & Storage Temperature Range
1N6638	150	125			
1N6639	100	75			
1N6640	75	50			
1N6641	75	50	300 mA	2.5 A (pk)	-65°C to +200°C
1N6642	100	75			1
1N6643	75	50			

^{1.} See derating curve.



Silicon Switching Diode

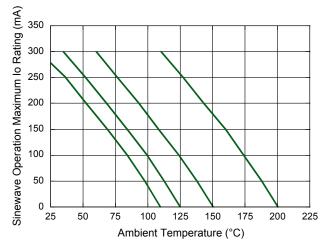
Rev. V2

Thermal Characteristics²

Characteristics	Symbol	Max. Value
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	325°C/W
Thermal Resistance, Junction to Solder Pad	R _{0JSP}	100°C/W

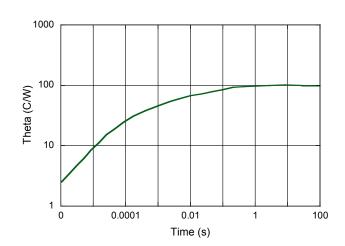
^{2.} See thermal impedance curve.

Temperature - Current Derating



Sinewave Operation 50% Duty Cycle, $R_{\rm BJA}$ (PCB) = 325°C/W. Maximum Finish-Alloy Temperature = 175°C

Thermal Impedance

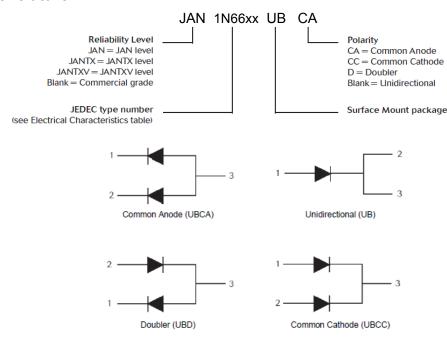




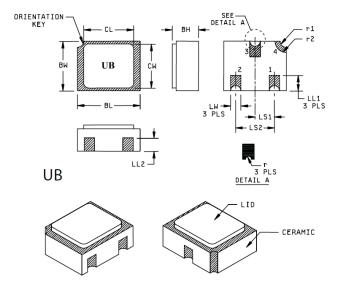
Silicon Switching Diode

Rev. V2

Parts Nomenclature



Outline Drawing (UB)



Case: Ceramic

Thermals: Gold plating over nickel under plate.

Tape & Reel option: Standard per EIA-4180. Consult factory for quantities.

. Weight: <0.04 grams

Dimensions^{3,4,5,6}

Cumbal	Inc	hes	Millimeters		
Symbol	Min. Max.		Min.	Max.	
ВН	0.046	0.056	1.17	1.42	
BL	0.115	0.128	2.92	3.25	
BW	0.085	0.108	2.16	2.74	
CL	-	0.128	-	3.25	
CW	-	0.108	-	2.74	
LL1	0.022	0.038	0.56	0.96	
LL2	0.017	0.035	0.43	0.89	
LS ₁	0.035	0.039	0.89	0.99	
LS ₂	0.071	0.079	1.81	2.01	
LW	0.016	0.024	0.41	0.61	
r	-	0.008	-	0.203	
r ₁	-	0.012	-	0.305	
r ₂	-	0.022	-	0.559	

- 3. Dimensions are in inches. Millimeters are given for general information only.
- 4. Hatched areas on package denote metallized areas.
- Pad 1 = Base, Pad 2 = Emitter, Pad 3 = Collector, Pad 4 = Shielding connected to the lid.
- In accordance with ASME Y14.5M, diameters are equivalent to φx symbology.

4

VPT Components and its affiliates reserve the right to make changes to the product(s) or information contained herein without notice.

Visit www.vptcomponents.com for additional data sheets and product information.



Silicon Switching Diode

Rev. V2

VPT Components All rights reserved.

Information in this document is provided in connection with VPT Components' products. These materials are provided by VPT Components as a service to its customers and may be used for informational purposes only. Except as provided in VPT Components' Terms and Conditions of Sale for such products or in any separate agreement related to this document, VPT Components assumes no liability whatsoever. VPT Components assumes no responsibility for errors or omissions in these materials. VPT Components may make changes to specifications and product descriptions at any time, without notice. VPT Components makes no commitment to update the information and shall have no responsibility whatsoever for conflicts or incompatibilities arising from future changes to its specifications and product descriptions. No license, express or implied, by estoppels or otherwise, to any intellectual property rights is granted by this document.

THESE MATERIALS ARE PROVIDED "AS IS" WITHOUT WARRANTY OF ANY KIND, EITHER EXPRESS OR IMPLIED, RELATING TO SALE AND/OR USE OF VPT COMPONENTS' PRODUCTS INCLUDING LIABILITY OR WARRANTIES RELATING TO FITNESS FOR A PARTICULAR PURPOSE, CONSEQUENTIAL OR INCIDENTAL DAMAGES, MERCHANTABILITY, OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT. VPT COMPONENTS FURTHER DOES NOT WARRANT THE ACCURACY OR COMPLETENESS OF THE INFORMATION, TEXT, GRAPHICS OR OTHER ITEMS CONTAINED WITHIN THESE MATERIALS. VPT COMPONENTS SHALL NOT BE LIABLE FOR ANY SPECIAL, INDIRECT, INCIDENTAL, OR CONSEQUENTIAL DAMAGES, INCLUDING WITHOUT LIMITATION, LOST REVENUES OR LOST PROFITS, WHICH MAY RESULT FROM THE USE OF THESE MATERIALS.

VPT Components' products are not intended for use in medical, lifesaving or life sustaining applications. VPT Components' customers using or selling VPT Components' products for use in such applications do so at their own risk and agree to fully indemnify VPT Components for any damages resulting from such improper use or sale.